5TH EUROPEAN SILICON DAYS
20-22 SEPTEMBER 2009
VIENNA, AUSTRIA

1ST CIRCULAR
PLACE AND DATE

We are pleased to announce that the 5th European Silicon Days will be held in Vienna, Austria between the 20th and 22nd of September 2009.

This follows the highly successful European Silicon Days conferences in Munich in 2001 and 2003, in Würzburg in 2005 (jointly with the International Silicon Symposium) and in Bath in 2007.

Vienna, also described as Europe’s cultural capital, is a metropolis with unique charm and flair. It boasts outstanding infrastructure, and has all the inspiration you could wish for.

Vienna is situated in the North-East of Austria and lies on the banks of the majestic Danube river. Vienna is not only surrounded by the Wachau region and Wiener Wald, but also by Lake Neusiedel and the eastern part of the Alps, with numerous green expanses and parks.

Vienna is an exceptionally agreeable city. For more information see:

www.aboutvienna.org/

The scientific events will be held at the Academy of Sciences as well as on the campus of TU Wien.

SCIENTIFIC PROGRAMME

The programme will cover a wide selection of topics in synthetic, mechanistic, theoretical and industrially relevant silicon chemistry such as:

- silicon-based polymers and materials, including silicones, silsesquioxanes, hybrids, nanochemistry, composites, catalysis etc;
- biosilicon chemistry;
- multiply bonded species and reaction intermediates;
- and hypervalent silicon compounds.

There will be oral and poster presentations. You will be invited to submit abstracts for consideration.

More details including Plenary Lecturers and how to submit abstracts will be given in the Second Circular which will be available in November 2008. The conference language will be English.
Registration will open in January 2009. On-line registration and payment will be available and an Early Bird rate will be offered.

Further details will be given in the Second Circular in November 2008.

The Belvedere Palace.
WHO TO CONTACT

The Conference Administrator (general enquiries and sponsorship):
Contact Michele Sahrle
e-mail: ESD@mmsconferencing.com
www.mmsconferencing.com/eod09/organosilicon.php

The Programme Chair is
Ulrich Schubert,
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The Conference Chair is
Florian Schattenmann,
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SPONSORS

Current sponsors include Momentive, Dow Corning and TU Wien. Further sponsors will be welcomed.

SOCIAL PROGRAMME

There will be a Welcome Reception on Sunday the 20th of September.

A Poster and Wine Session will be held at the Palais Eschenbach on Monday the 21st of September.

There will be a Conference Dinner on the 22nd of September - venue yet to be announced.